WINSOURCE ELECTRONICS

THE DATASHEET OF

LM79L12ACM

LM79LXXAC Series 3-Terminal Negative Regulators

Check for Samples: LM79L05, LM79L12, LM79L12AC, LM79L15, LM79L15AC

FEATURES

- **Preset Output Voltage Error is Less than ±5% Over Load, Line and Temperature**
- **Specified at an Output Current of 100mA**
- **Easily Compensated with a Small 0.1µF Output Capacitor**
- **Internal Short-Circuit, Thermal and Safe Operating Area Protection**
- **Easily Adjustable to Higher Output Voltages**
- **Maximum Line Regulation Less than 0.07% V_{OUT}/V**
- **Maximum Load Regulation Less than 0.01% V_{OUT}/mA**
- **See AN-1112 (SNVA009) for DSBGA Considerations**

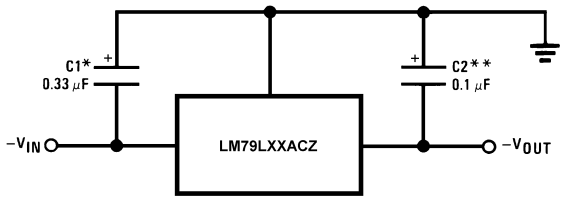
DESCRIPTION

The LM79LXXAC series of 3-terminal negative voltage regulators features fixed output voltages of −5V, −12V, and −15V with output current capabilities in excess of 100mA. These devices were designed using the latest computer techniques for optimizing the packaged IC thermal/electrical performance. The LM79LXXAC series, when combined with a minimum output capacitor of 0.1µF, exhibits an excellent transient response, a maximum line regulation of 0.07% V_O/V, and a maximum load regulation of 0.01% V_O/mA.

The LM79LXXAC series also includes, as self-protection circuitry: safe operating area circuitry for output transistor power dissipation limiting, a temperature independent short circuit current limit for peak output current limiting, and a thermal shutdown circuit to prevent excessive junction temperature. Although designed primarily as fixed voltage regulators, these devices may be combined with simple external circuitry for boosted and/or adjustable voltages and currents. The LM79LXXAC series is available in the 3-lead TO package, the 8-lead SOIC package, and the 6-Bump DSBGA package.

For output voltages other than the pre-set -5V, -12V and -15V, the LM137L series provides an adjustable output voltage range from -1.2V to -47V.

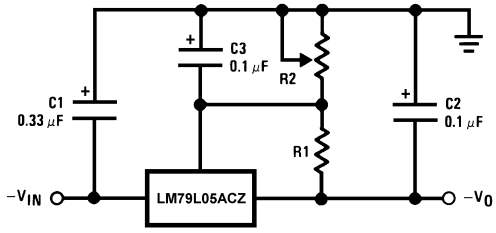
Typical Applications



*Required if the regulator is located far from the power supply filter. A 1µF aluminum electrolytic may be substituted.

**Required for stability. A 1µF aluminum electrolytic may be substituted.

Figure 1. Fixed Output Regulator



$-V_0 = -5V - (5V/R1 + I_Q) \bullet R2$,
$5V/R1 > 3\ I_Q$

Figure 2. Adjustable Output Regulator

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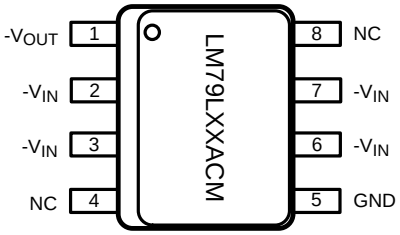
These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

Connection Diagram



Pins labeled 'NC' on LM79LXXACM 8-Lead SOIC (pin 4 and pin 8) are Open, no internal connection.

Figure 3. 8-Lead SOIC Narrow (D)
Top View

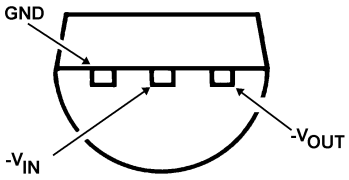


Figure 4. 3–Lead TO-226 (LP)
Bottom View

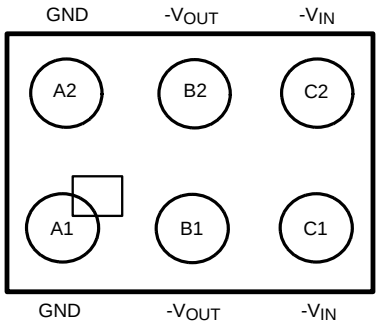


Figure 5. 6-Bump DSBGA
Top View (Bump Side Down)

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Absolute Maximum Ratings[1][2]

Input Voltage	
V_O = −5V, −12V, −15V	−35V
Internal Power Dissipation [3]	Internally Limited
Operating Temperature Range	0°C to +70°C
Maximum Junction Temperature	+125°C
Storage Temperature Range	−55°C to +150°C
Lead Temperature	
(Soldering, 10 sec.)	260°C

(1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional.
(2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/Distributors for availability and specifications.
(3) Thermal resistance of TO-226 (LP) package is 60°C/W θ_{JC}, 232°C/W θ_{JA} at still air, and 88°C/W at 400 ft/min of air. The θ_{JA} of the LM78LXX in the 6-Bump DSBGA package is 114°C/W when mounted on a 4-Layer JEDEC test board (JESD 51-7). The θ_{JA} of the LM78LXX in the SOIC-8 (D) package is 180°C/W in still air. The maximum junction temperature shall not exceed 125°C on electrical parameters.

Electrical Characteristics [1]

T_A = 0°C to +70°C unless otherwise noted.

Output Voltage			**−5V**			**−12V**			**−15V**			
Input Voltage (unless otherwise noted)			**−10V**			**−17V**			**−20V**			
Symbol	**Parameter**	**Conditions**	**Min**	**Typ**	**Max**	**Min**	**Typ**	**Max**	**Min**	**Typ**	**Max**	**Units**
V_O	Output Voltage	T_J = 25°C, I_O = 100mA	−5.2	−5	−4.8	−12.5	−12	−11.5	−15.6	−15	−14.4	V
		1mA ≤ I_O ≤ 100mA	−5.25		−4.75	−12.6		−11.4	−15.75		−14.25	
		V_{MIN} ≤ V_{IN} ≤ V_{MAX}	(−20 ≤ V_{IN} ≤ −7.5)			(−27 ≤ V_{IN} ≤ −14.8)			(−30 ≤ V_{IN} ≤ −18)			
		1mA ≤ I_O ≤ 40mA	−5.25		−4.75	−12.6		−11.4	−15.75		−14.25	
		V_{MIN} ≤ V_{IN} ≤ V_{MAX}	(−20 ≤ V_{IN} ≤ −7)			(−27 ≤ V_{IN} ≤ −14.5)			(−30 ≤ V_{IN} ≤ −17.5)			
ΔV_O	Line Regulation	T_J = 25°C, I_O = 100mA			60			45			45	mV
		V_{MIN} ≤ V_{IN} ≤ V_{MAX}	(−20 ≤ V_{IN} ≤ −7.3)			(−27 ≤ V_{IN} ≤ −14.6)			(−30 ≤ V_{IN} ≤ −17.7)			V
		T_J = 25°C, I_O = 40mA			60			45			45	mV
		V_{MIN} ≤ V_{IN} ≤ V_{MAX}	(−20 ≤ V_{IN} ≤ −7)			(−27 ≤ V_{IN} ≤ −14.5)			(−30 ≤ V_{IN} ≤ −17.5)			V
ΔV_O	Load Regulation	T_J = 25°C			50			100			125	mV
		1mA ≤ I_O ≤ 100mA										
ΔV_O	Long Term Stability	I_O = 100mA		20			48			60		mV/khrs
I_Q	Quiescent Current	I_O = 100mA		2	6		2	6		2	6	mA
ΔI_Q	Quiescent Current Change	1mA ≤ I_O ≤ 100mA			0.3			0.3			0.3	
		1mA ≤ I_O ≤ 40mA			0.1			0.1			0.1	mA
		I_O = 100mA			0.25			0.25			0.25	mA
		V_{MIN} ≤ V_{IN} ≤ V_{MAX}	(−20 ≤ V_{IN} ≤ −7.5)			(−27 ≤ V_{IN} ≤ −14.8)			(−30 ≤ V_{IN} ≤ −18)			V
V_n	Output Noise Voltage	T_J = 25°C, I_O = 100mA f = 10Hz − 10kHz		40			96			120		µV
$\Delta V_{IN}/\Delta V_O$	Ripple Rejection	T_J = 25°C, I_O = 100mA f = 120Hz	50			52			50			dB
	Input Voltage Required to Maintain Line Regulation	T_J = 25°C, I_O = 100mA			−7.3			−14.6			−17.7	V
		I_O = 40mA			−7.0			−14.5			−17.5	V

(1) To ensure constant junction temperature, low duty cycle pulse testing is used.

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Typical Performance Characteristics

Maximum Average Power Dissipation (TO-226)

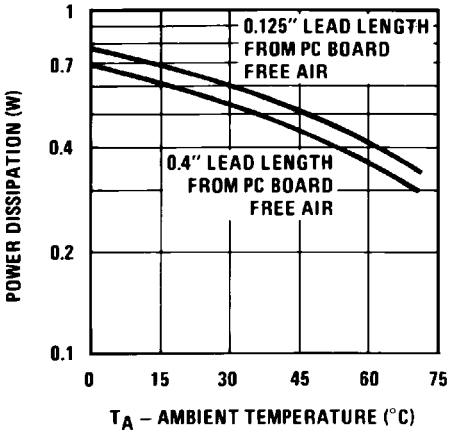

Figure 6.

Peak Output Current

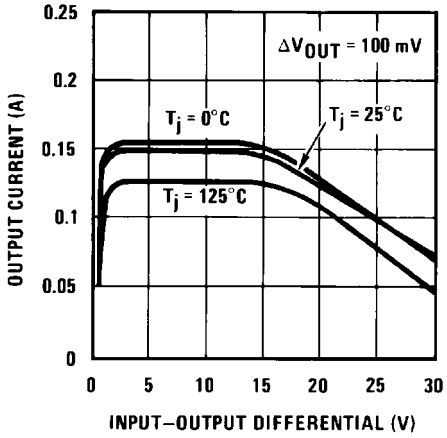

Figure 7.

Short Circuit Output Current

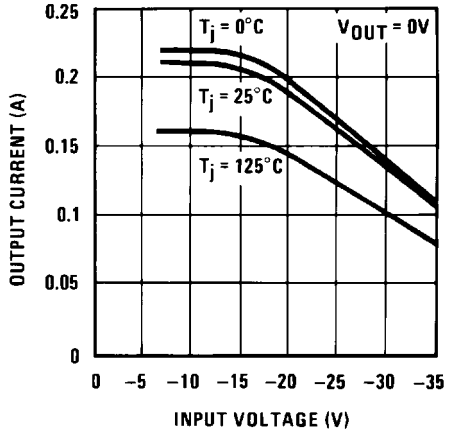

Figure 8.

Dropout Voltage

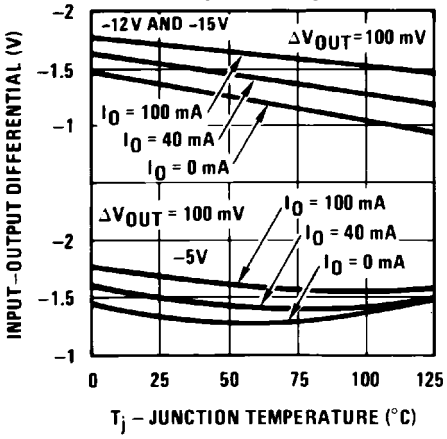

Figure 9.

Ripple Rejection

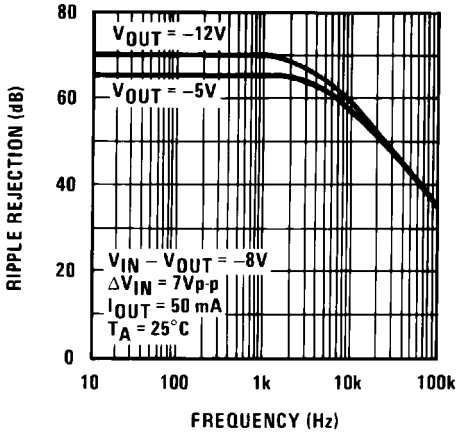

Figure 10.

Output Voltage vs. Temperature (Normalized to 1V @ 25°C)

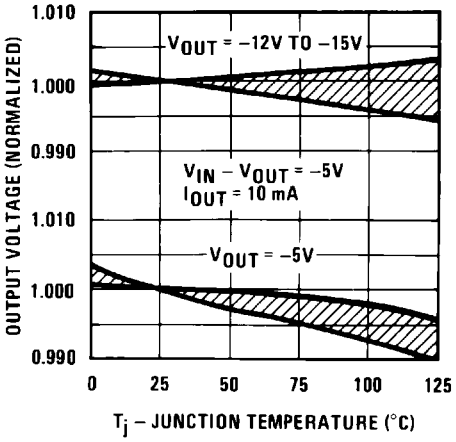

Figure 11.

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Typical Performance Characteristics (continued)

Quiescent Current

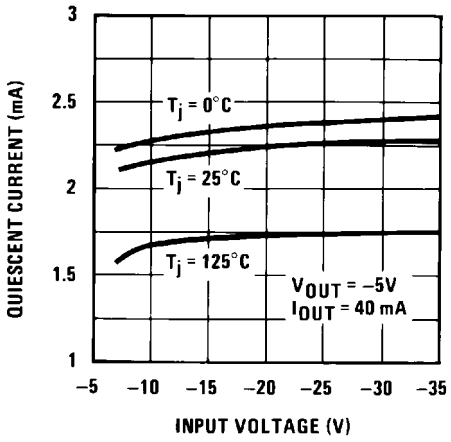

Figure 12.

Output Impedance

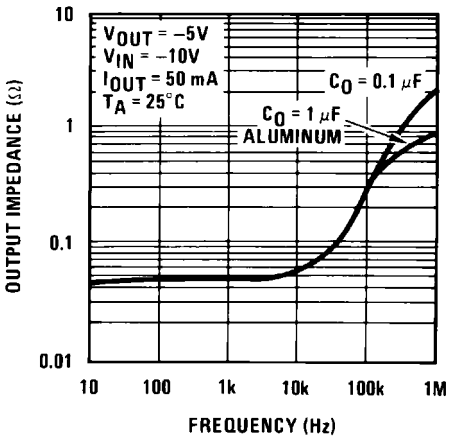

Figure 13.

TYPICAL APPLICATIONS

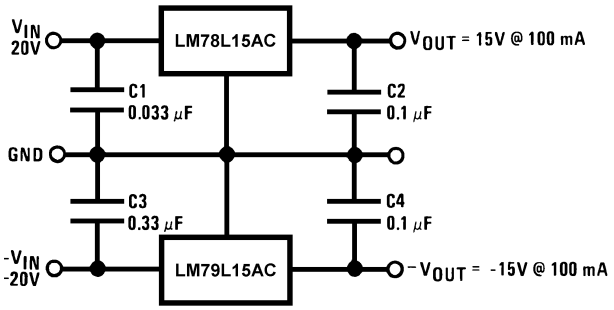

Figure 14. ±15V, 100mA Dual Power Supply

Schematic Diagrams

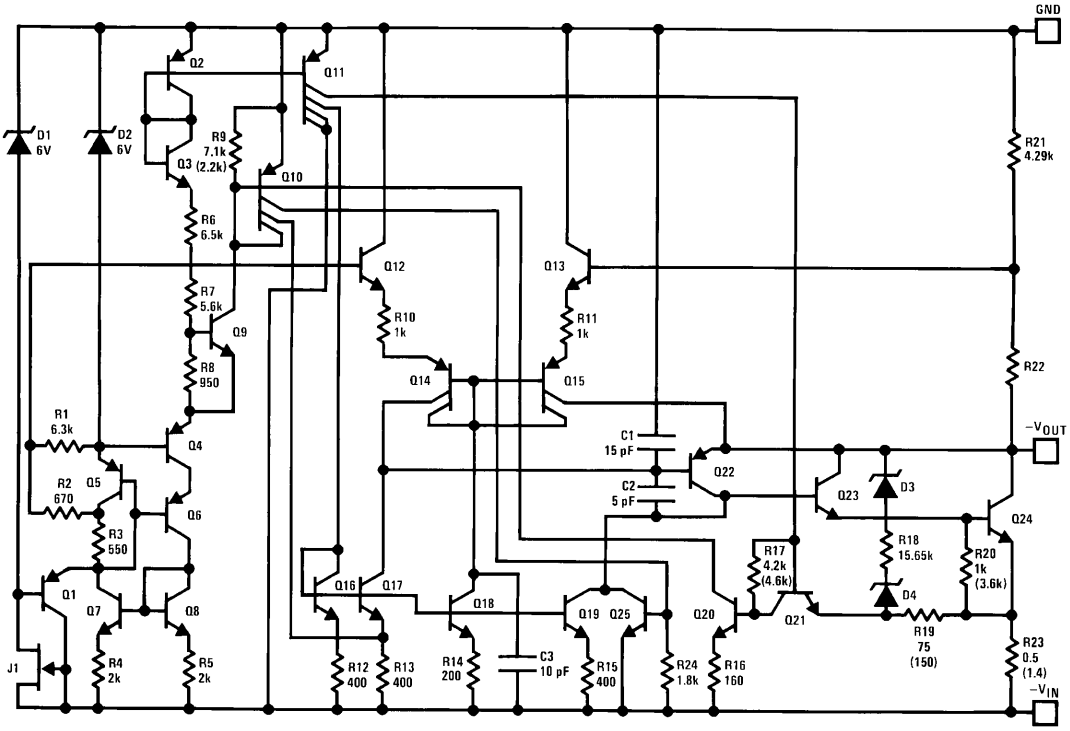

Figure 15. −5V Schematic Diagram

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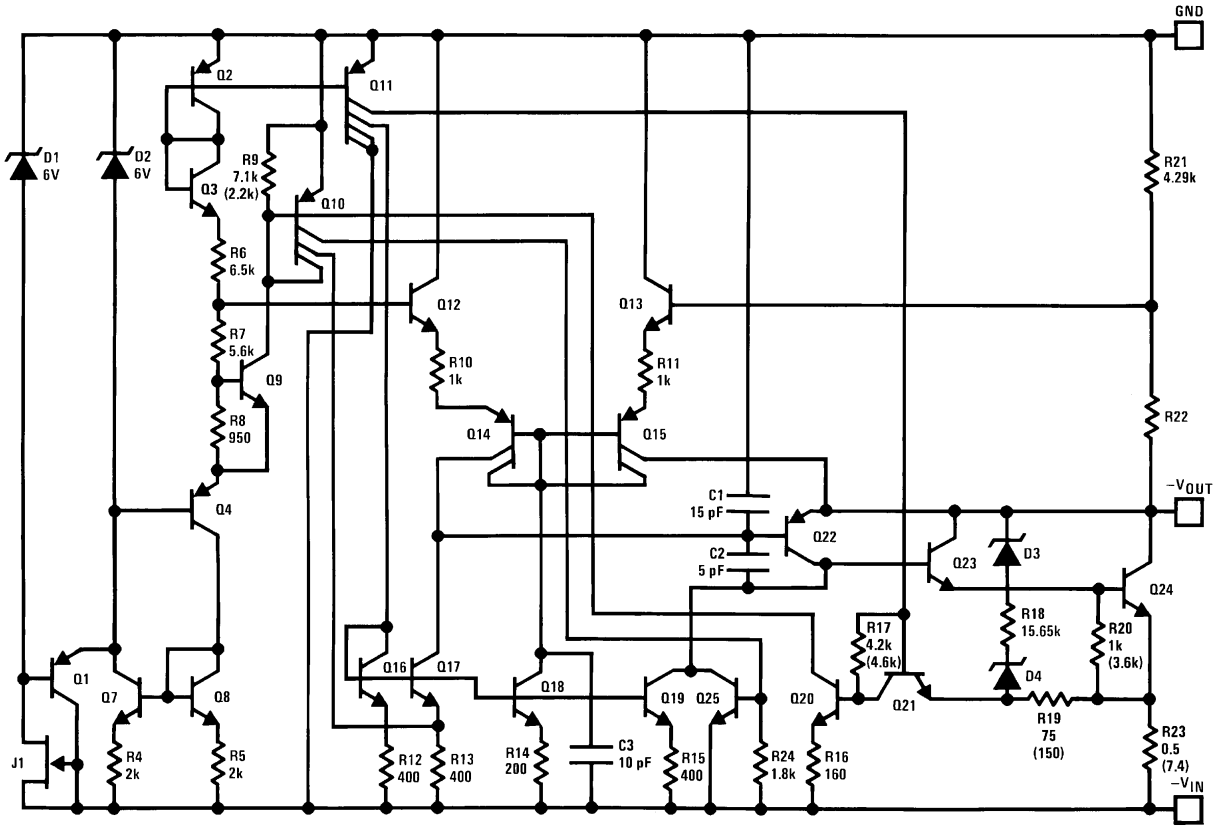

Figure 16. −12V and −15V Schematic Diagram

REVISION HISTORY

Changes from Revision J (April 2013) to Revision K	**Page**
• Changed layout of National Data Sheet to TI format	7

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PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
LM79L05ACM	NRND	SOIC	D	8	95	TBD	Call TI	Call TI	0 to 70	LM79L 05ACM	
LM79L05ACM/NOPB	ACTIVE	SOIC	D	8	95	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	0 to 70	LM79L 05ACM	Samples
LM79L05ACMX/NOPB	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	0 to 70	LM79L 05ACM	Samples
LM79L05ACTL/NOPB	ACTIVE	DSBGA	YZR	6	250	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM	0 to 70	P B	Samples
LM79L05ACTLX/NOPB	ACTIVE	DSBGA	YZR	6	3000	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM	0 to 70	P B	Samples
LM79L05ACZ/LFT1	ACTIVE	TO-92	LP	3	2000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type		320L 79L05	Samples
LM79L05ACZ/NOPB	ACTIVE	TO-92	LP	3	1800	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	0 to 70	320L 79L05	Samples
LM79L12ACM	NRND	SOIC	D	8	95	TBD	Call TI	Call TI	0 to 70	LM79L 12ACM	
LM79L12ACM/NOPB	ACTIVE	SOIC	D	8	95	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	0 to 70	LM79L 12ACM	Samples
LM79L12ACMX/NOPB	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	0 to 70	LM79L 12ACM	Samples
LM79L12ACZ/LFT4	ACTIVE	TO-92	LP	3	2000	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type		320L 79L12	Samples
LM79L12ACZ/NOPB	ACTIVE	TO-92	LP	3	1800	Green (RoHS & no Sb/Br)	CU SN	N / A for Pkg Type	0 to 70	320L 79L12	Samples
LM79L15ACM	NRND	SOIC	D	8	95	TBD	Call TI	Call TI	0 to 70	LM79L 15ACM	
LM79L15ACM/NOPB	ACTIVE	SOIC	D	8	95	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	0 to 70	LM79L 15ACM	Samples
LM79L15ACMX/NOPB	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	0 to 70	LM79L 15ACM	Samples

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".
RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.
Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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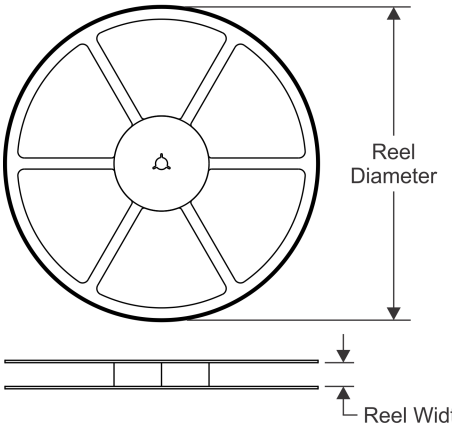
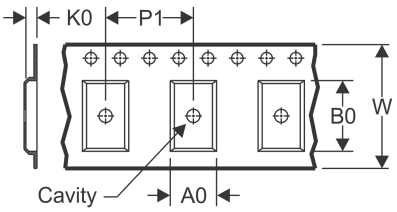
TAPE AND REEL INFORMATION

REEL DIMENSIONS

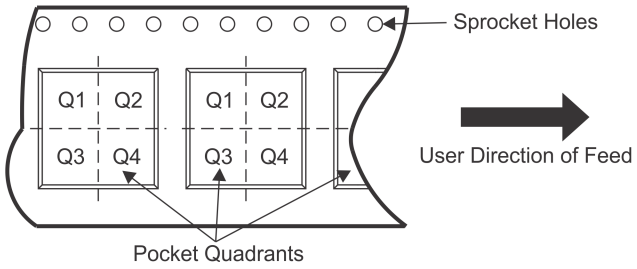


TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

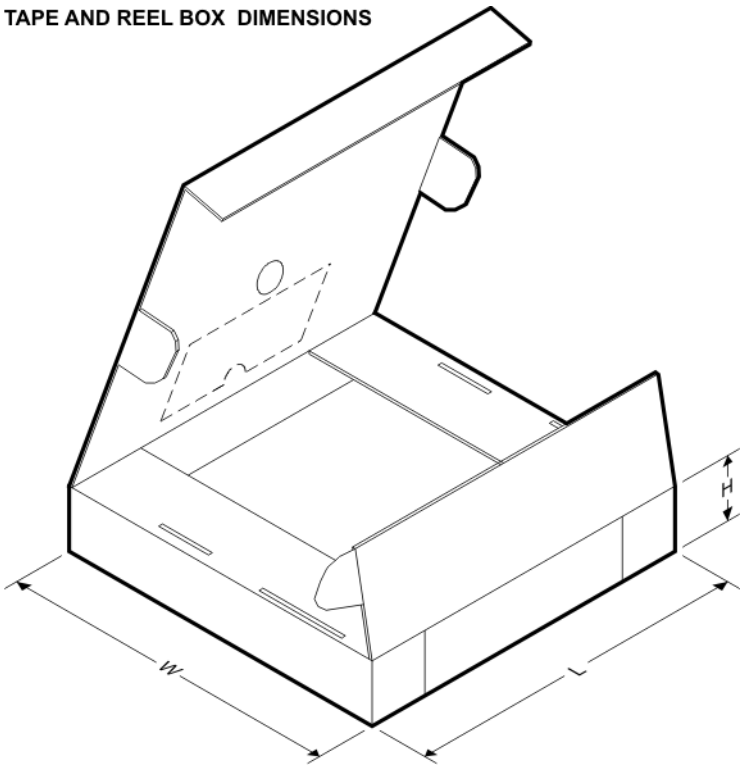
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

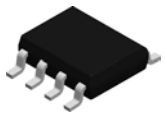
Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM79L05ACMX/NOPB	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1
LM79L05ACTL/NOPB	DSBGA	YZR	6	250	178.0	8.4	1.09	1.88	0.76	4.0	8.0	Q1
LM79L05ACTLX/NOPB	DSBGA	YZR	6	3000	178.0	8.4	1.09	1.88	0.76	4.0	8.0	Q1
LM79L12ACMX/NOPB	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1
LM79L15ACMX/NOPB	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM79L05ACMX/NOPB	SOIC	D	8	2500	367.0	367.0	35.0
LM79L05ACTL/NOPB	DSBGA	YZR	6	250	210.0	185.0	35.0
LM79L05ACTLX/NOPB	DSBGA	YZR	6	3000	210.0	185.0	35.0
LM79L12ACMX/NOPB	SOIC	D	8	2500	367.0	367.0	35.0
LM79L15ACMX/NOPB	SOIC	D	8	2500	367.0	367.0	35.0

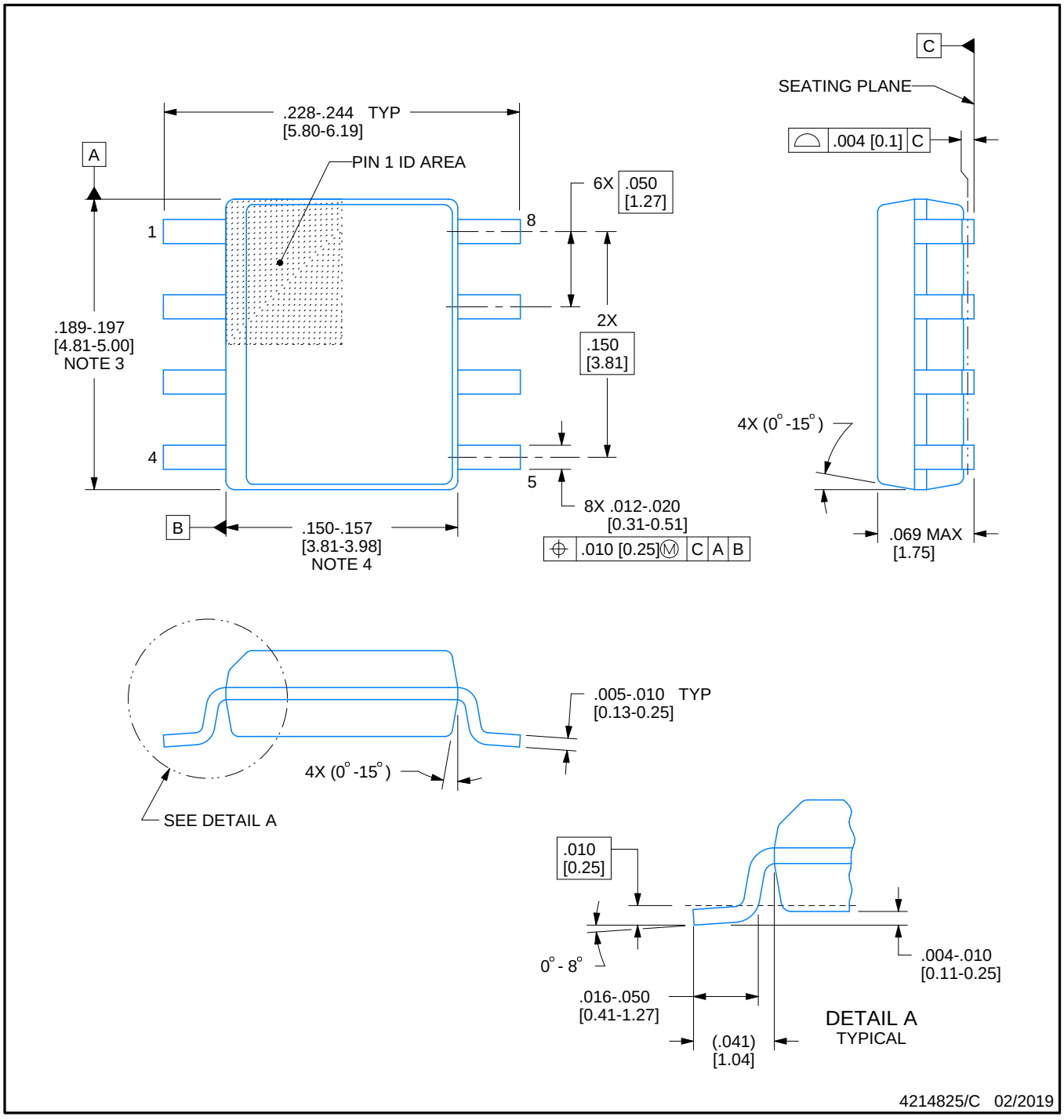


PACKAGE OUTLINE

D0008A

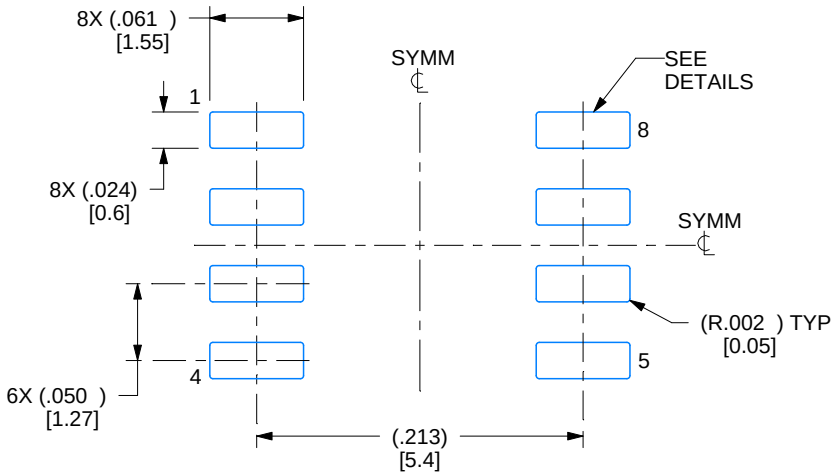
SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT

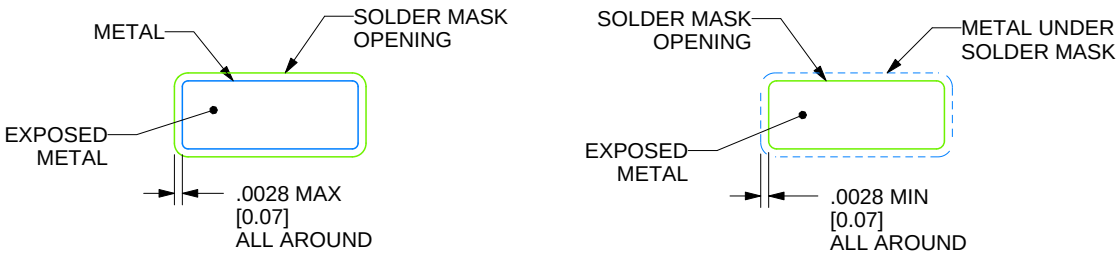


NOTES:

1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
4. This dimension does not include interlead flash.
5. Reference JEDEC registration MS-012, variation AA.



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:8X



SOLDER MASK DETAILS

4214825/C 02/2019

NOTES: (continued)

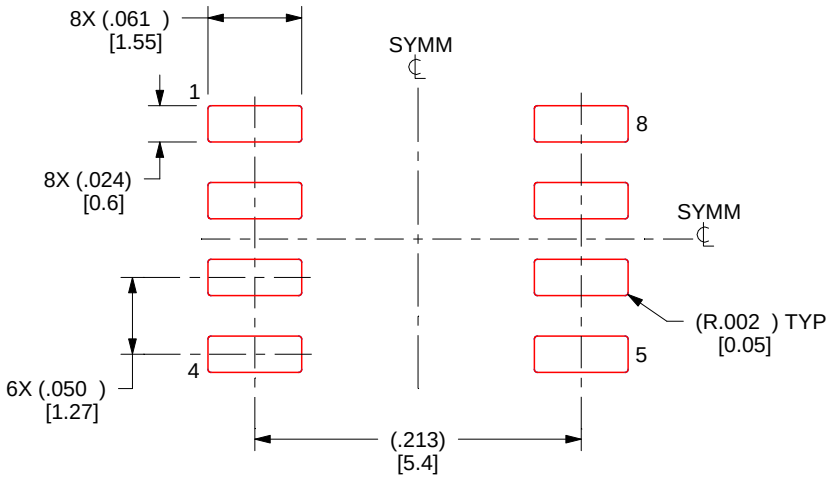
6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE
BASED ON .005 INCH [0.125 MM] THICK STENCIL
SCALE:8X

4214825/C 02/2019

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

LP 3 TO-92 - 5.34 mm max height

TRANSISTOR OUTLINE

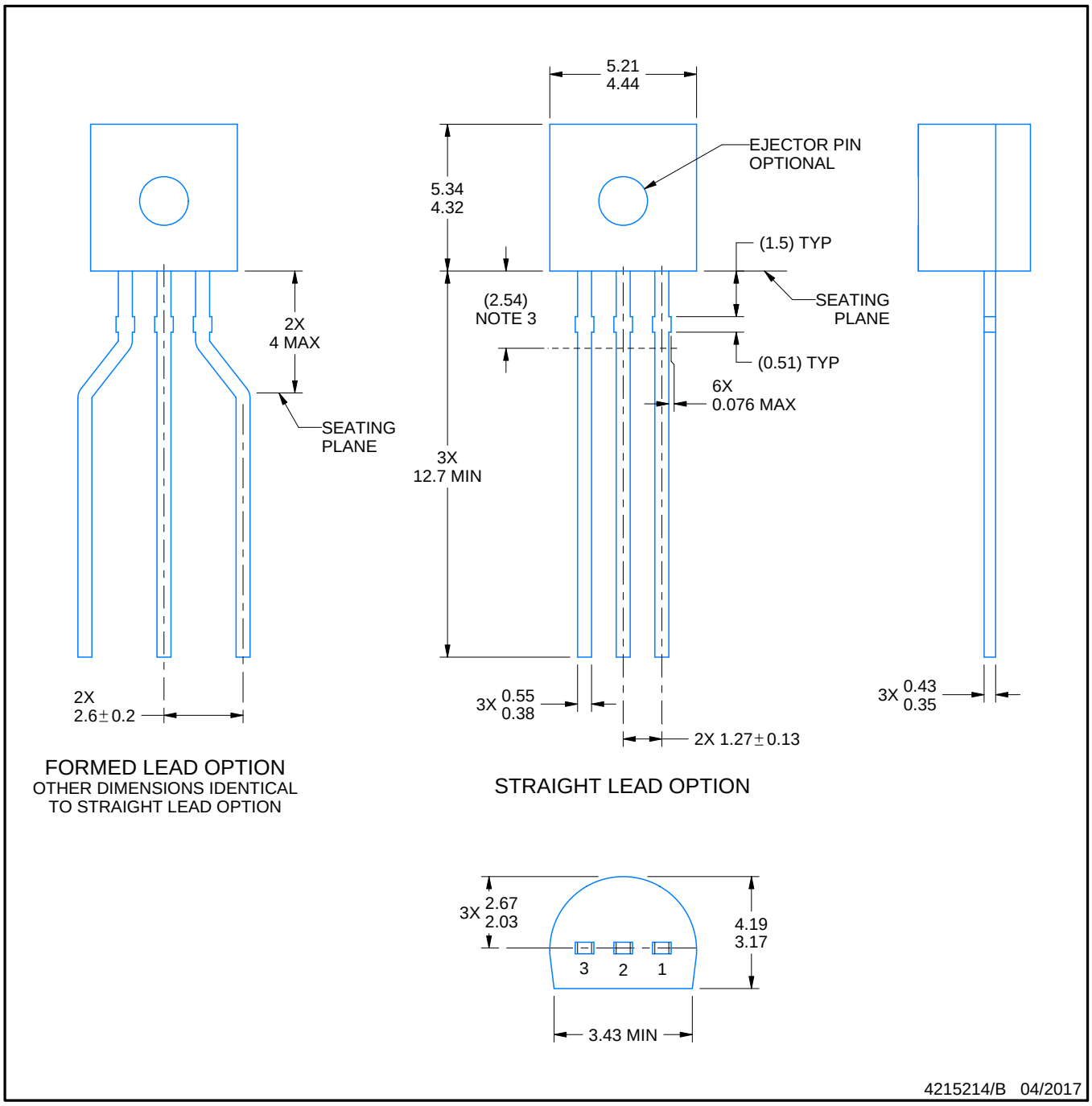
Images above are just a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.

LP0003A

PACKAGE OUTLINE

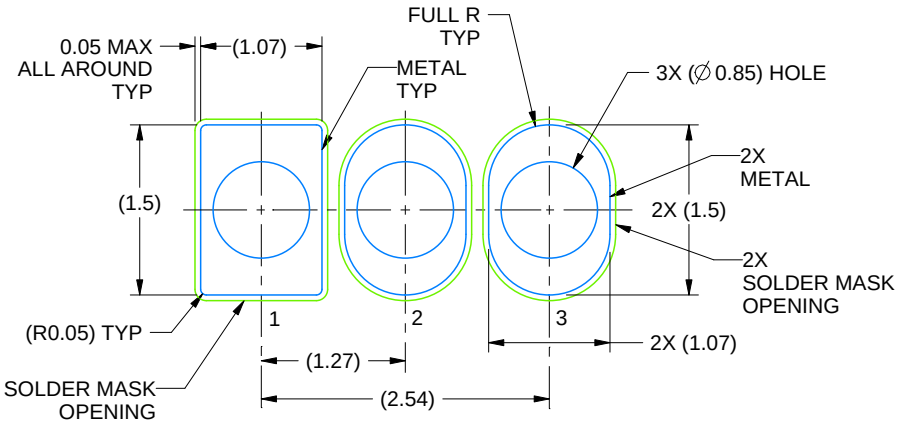
TO-92 - 5.34 mm max height

TO-92

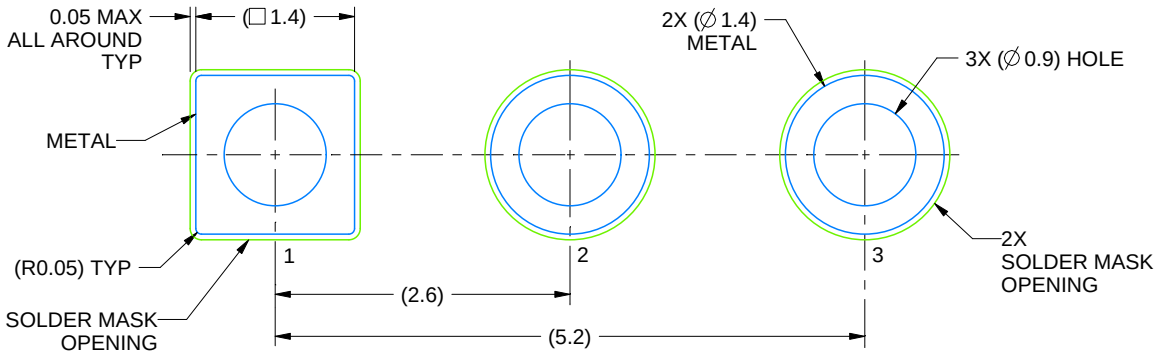


NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Lead dimensions are not controlled within this area.
4. Reference JEDEC TO-226, variation AA.
5. Shipping method:
   a. Straight lead option available in bulk pack only.
   b. Formed lead option available in tape and reel or ammo pack.
   c. Specific products can be offered in limited combinations of shipping medium and lead options.
   d. Consult product folder for more information on available options.



LAND PATTERN EXAMPLE
STRAIGHT LEAD OPTION
NON-SOLDER MASK DEFINED
SCALE:15X



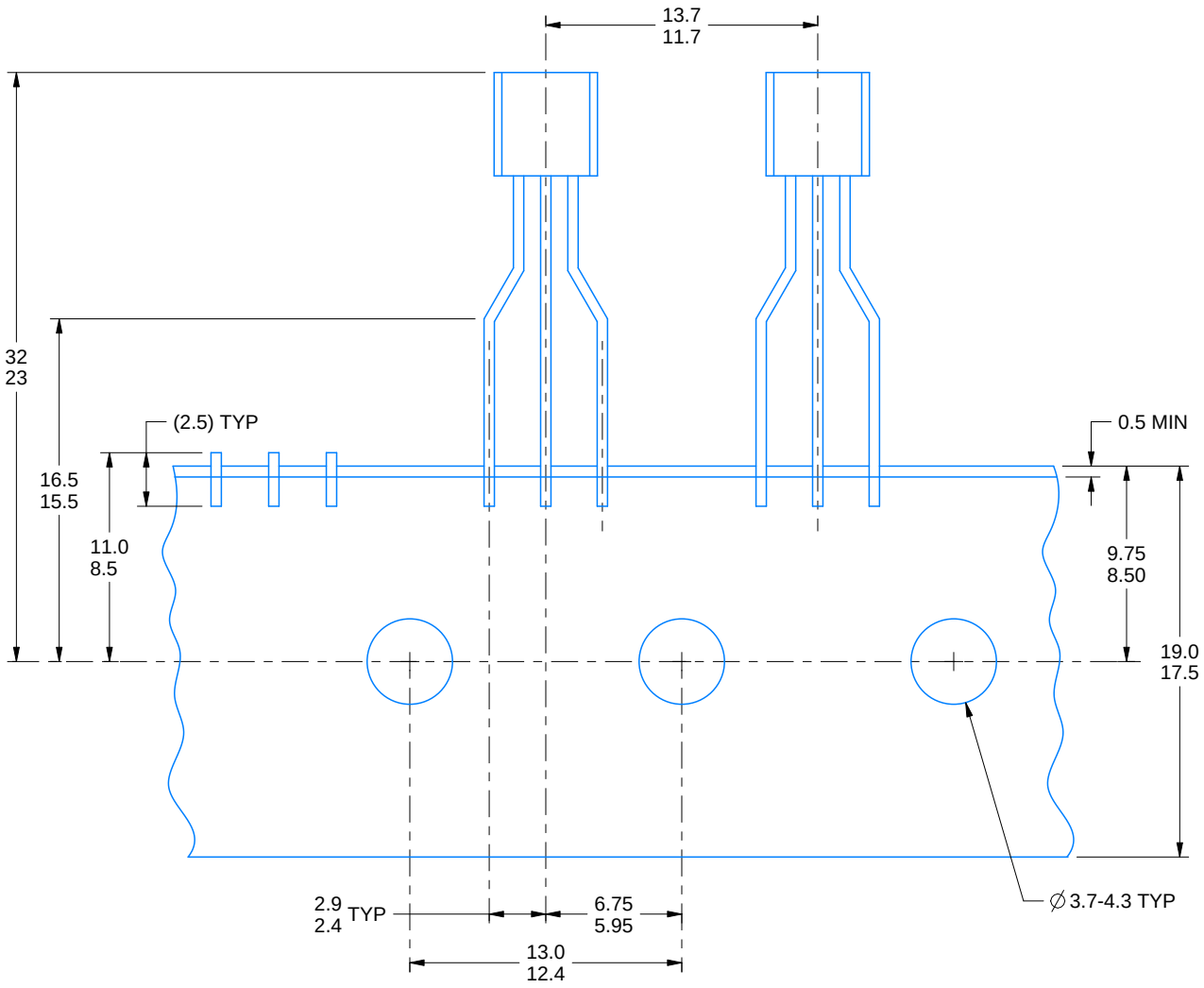
LAND PATTERN EXAMPLE
FORMED LEAD OPTION
NON-SOLDER MASK DEFINED
SCALE:15X

4215214/B 04/2017

LP0003A

TO-92 - 5.34 mm max height

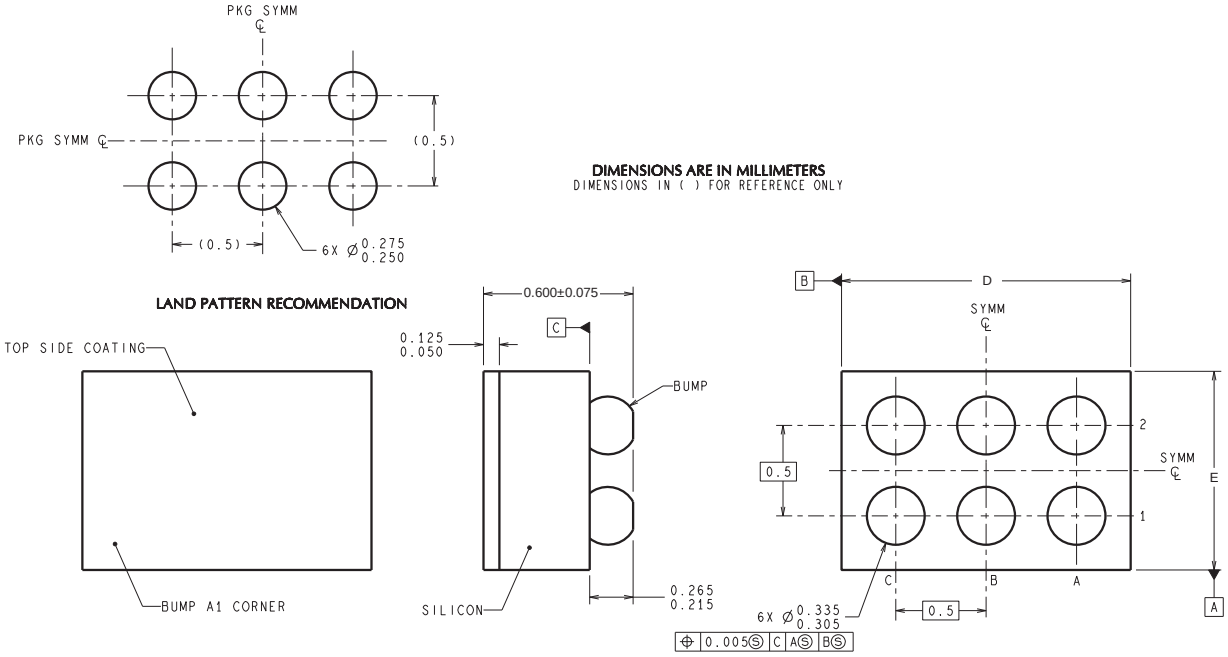
TO-92



FOR FORMED LEAD OPTION PACKAGE

4215214/B 04/2017

YZR0006



TLA06XXX (Rev C)

D: Max = 1.845 mm, Min =1.784 mm

E: Max = 1.057 mm, Min =0.996 mm

4215044/A 12/12

NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
B. This drawing is subject to change without notice.

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